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Docket No.

## Declaration For U.S. Patent Application

My residence, pos I believe I am the	inventor, I hereby declare that: st office address and citizenship at original, first and sole inventor (i elow) of the subject matter which NGINE STARTING API	re as stated below my to f only one name is liste is claimed and for wh	name. ed below) or an original, fit ich a patent is sought on the	rst and joint inventor (if plural
	f which is attached hereto unless			
□ was file	d on	·	as PCT Intern	ational Application
Number	was filed on as PCT International Applica Number and was amended on and/or was filed on as United States Application Number and was amended on			es Application
and/or was file Number	o on	and was	amended on	·
I hereby state that by any amendmen I acknowledge the I hereby claim for certificate, or §36 below and have all	I have reviewed and understand the treferred to above. duty to disclose information whice the priority benefits under 35 U.S (a) of any PCT International application below any foreign a before that of the application(s)	contents of the above- ich is material to patent S.C. §119(a)-(d) or §36 ication which designat pplication for patent o	identified specification, inclusionability as defined in 37 C.F (5) of any foreign applicated at least one country other inventor's certificate or F	uding the claim(s), as amended  .R. §1.56. tion(s) for patent or inventor's r than the United States, listed
	P. 2001-003056	Japan	10/01/2001	1.00 X Yes No
(List prior foreign	(Number)	(Country)	(Day/Month/Year File	ed)
applications.	P. 2001-325604 (Number)	Japan (Country)	10/01/2001 (Day/Month/Year File 23/10/2001 (Day/Month/Year File	Z Yes □ No ed)
See note A on back of			(Day/Month/Year File	UYES UNO
this page)	(Number)	(Country)	•	
I hereby claim the	benefit under 35 U.S.C. §119(e)	of any United States p	rovisional application(s) list	ted below.
	(Application Number)	(Filing	Date)	<del></del>
	(Application Number)	(Filing	Date)	<del></del>
(See Note B on b.	sek 🔲 See attached li	ist for additional prior	foreign or provisional appli	cations.
designating the Ur disclosed in the pr the duty to disclos filing date of the p	benefit under 35 U.S.C. §120 of a nited States of America listed below ior application(s) (U.S. or PCT) in e information which is material to prior application and the national of	v and, insofar as the sun the manner provided in patentability as defined	bject matter of each of the cl by the first paragraph of 35, 1 in 37 C.F.R. §1.56 which	laims of this application is not U.S.C. §112, I acknowledge became available between the
(List prior U.S. Applications or PCT International	(Application Serial No.)	(Filing Date)	(Status) (pa	atented, pending, abandoned)
applications designating the U.S.)	(Application Serial No.)	(Filing Date)	(Status) (pa	atented, pending, abandoned)
George E. Oram, Goldhush, Reg.	oint as principal attorneys: Davi Jr., Reg. No. 27,931; Robert B No. 33,125; Monica Chin Kitts, James A. Poulos, III, Reg. No. 31 . No. 44,275; Bradley D. Goldize	. Murray, Reg. No. 2 Reg. No. 36,105; R 714; Patrick D. Muir	2,980; E. Marcie Emas, R ichard J. Berman, Reg. N , Reg. No. 37,403; Sharon I	eg. No. 32,131; Douglas H. Vo. 39,107; King L. Wong, N. Klesner, Reg. No. 36,335;
Please direct all c	ommunications to the following ac	Washington,	KINTNER PLOTKIN & I ticut Avenue, N.W., Suite of D.C. 20036-5339	600
		Telephone N	o. (202) 857-6000; Facsimil	le No. (202) 638-4810
are believed to be	nat all statements made herein of m true; and further, that these states ble by fine or imprisonment, or bot hay jeopardize the validity of the a	nents were made with t th, under Section 1001	he knowledge that willful to of Title 18 of the United Sta	aise statements and the like so
(See Note C	Full name of sole or first java	entor A	Masashi TANAKA	·
on back of this page)	Inventor's signature That	pshi Jana	Ka	December 25, 200
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Full name of sixth ioint in	ventor, if any	
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Citizenship		
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Full name of seventh ioint	inventor, if any	
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ull name of ninth joint in	iventor, if any	
		Date